

**OZCG Series** 

HF 60 0ZCG Series -1812 Chip

RoHS 6 Compliant & Halogen-Free

**Product Features** Application

All high-density boards 1812 Chip Size, Fast Trip Time, Low DCR Resistance

Operating (Hold Current) Range

100mA - 3A

Maximum Voltage Temperature Range

6 - 60V (per table) -40°C to 85°C

Agency Approval

TUV (Std. EN60738-1-1, Cert. R50102117 & R50102187)

UL Component (Std. UL1434, File E305051)

UL Conditions of Acceptability:

- 1. These devices have been investigated for use in safety circuits and are suitable as a limiting device.
- 2. These devices have been calibrated to limit the current to 8 amps within 5 seconds, per ANSI/NFPA 70, "National Electrical Code".

LEAD FREE = (Pb)

HALOGEN FREE = HF



AUV CAN'IIS

	Part Number	Hold Current	Trip	Rated		Typical Power Pd, W	Max Time to Trip		Resistance Tolerance		Agency Approvals	
			Current	Voltage			Current A	Time Sec	Rmin Ohms	R1max Ohms	c <b>71</b> 2° us	Α̈́τüν
			IT, A	Vmax, Vdc								
Α	0ZCG0010FF2C	0.10	0.30	60	100	0.8	8.0	0.020	1.600	15.00	Υ	Y
В	0ZCG0014FF2C	0.14	0.30	60	10	0.8	8.0	0.008	1.200	6.500	Y	Υ
C ·	0ZCG0020FF2C	0.20	0.40	30	10	0.8	8.0	0.020	0.800	5.000	Υ	Υ
	0ZCG0020AF2C	0.20	0.40	60	40	0.8	8.0	0.020	0.800	5.000	Y	Υ
	0ZCG0030FF2C	0.30	0.60	30	40	0.8	8.0	0.100	0.200	1.750	Υ	Υ
	0ZCG0035FF2C	0.35	0.70	16	40	0.8	8.0	0.100	0.320	1.500	Y	Y
Е	0ZCG0035AF2C	0.35	0.70	30	40	0.8	8.0	0.100	0.320	1.500	Υ	Υ
F G H	0ZCG0050FF2C	0.50	1.00	16	100	0.8	8.0	0.150	0.150	1.000	Y	Y
	0ZCG0050AF2C	0.50	1.00	30	100	0.8	8.0	0.150	0.150	1.000	Y	Υ
	0ZCG0075FF2C	0.75	1.50	16	100	0.8	8.0	0.200	0.110	0.450	Y	Y
	0ZCG0075AF2B	0.75	1.50	24	40	1.0	8.0	0.200	0.110	0.290	Y	Y
	0ZCG0075BF2B	0.75	1.50	33	40	1.0	8.0	0.200	0.110	0.400	Y	Y
	0ZCG0110FF2C	1.10	2.20	8	100	0.8	8.0	0.300	0.040	0.210	Y	Y
	0ZCG0110AF2C	1.10	2.20	16	100	0.8	8.0	0.500	0.040	0.180	Υ	Υ
	0ZCG0110BF2B	1.10	2.20	24	100	1.0	8.0	0.500	0.060	0.200	Y	Y
	S 0ZCG0110CF2B	1.10	2.20	33	100	0.8	8.0	0.500	0.060	0.200		Υ
	0ZCG0125FF2C	1.25	2.50	6	100	0.8	8.0	0.400	0.050	0.140	Y	Y
	0ZCG0125AF2B	1.25	2.50	16	100	0.8	8.0	0.400	0.050	0.140	Y	Y
	0ZCG0150FF2C	1.50	3.00	8	100	0.8	8.0	0.500	0.040	0.110	Y	Υ
	0ZCG0150AF2C	1.50	3.00	12	100	1.0	8.0	0.500	0.040	0.110	Y	Υ
	0ZCG0150BF2C	1.50	3.00	24	100	1.0	8.0	1.500	0.040	0.120	Y	Y
K ating	0ZCG0160FF2C	1.60	3.20	8	100	0.8	8.0	0.500	0.030	0.100	Y	Y
	0ZCG0160AF2C	1.60	3.20	12	100	1.0	8.0	1.000	0.030	0.100	Υ	Υ
	0ZCG0160BF2C	1.60	3.20	16	100	1.0	8.0	1.000	0.030	0.100	Y	Y
	0ZCG0200FF2C	2.00	3.50	8	100	1.0	8.0	2.000	0.020	0.070	Υ	Υ
	S 0ZCG0200AF2B	2.00	3.50	16	100	1.0	8.0	5.000	0.020	0.085	Y	Y
	0ZCG0260FF2C	2.60	5.00	8	100	1.0	8.0	2.500	0.015	0.047	Y	Υ
м	0ZCG0260AF2B	2.60	5.00	13.2	100	1.3	8.0	5.000	0.015	0.050	Y	Y
	0ZCG0260BF2B	2.60	5.00	16	100	1.3	8.0	5.000	0.015	0.050	Y	Υ
N	0ZCG0300FF2B	3.00	5.00	6	100	1.0	8.0	4.000	0.012	0.040	Y	Y

Hold Current-maximum current at which the device will not trip in still air at 23°C. Trip current-minimum current at which the device will always trip in still air at 23°C. ΙH

Maximum fault current device can withstand without damage at rated voltage (Vmax). **Imax** 

Maximum voltage device can withstand without damage at its rated current. Vmax

Typical power dissipated by device when in tripped state in 23°C still air environment.

Rmin Minimum device resistance at 23°C.

R1max Maximum device resistance at 23°C, 1 hour after initial device trip, or after being soldered to PCB in end application.



Specifications subject to change without notice

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RoHS 6 Compliant & Halogen-Free

# PTC's - Basic Theory of Operation / "Tripped" Resistance Explanation

Fundamentally, a Bel PTC consists of a block of polymeric material containing conductive filler and bonded between two conductive, planar terminations.

At currents below the device IHOLD rating, AND at temperatures below 100C, the PTC maintains a resistance value below its R1 MAX rating.

As the device's temperature approaches 130C, either due to an increase in ambient temperature or a current exceeding its ITRIP rating, volumetric expansion of the filled polymer breaks apart the majority of conductive pathways across the terminals created by chain contact of adjacent filler particles or device resistance increases sharply by several orders of magnitude.

At the much higher "Tripped" resistance, there is just enough leakage current to allow internal heating to "hold" the device in its tripped state (around 125C) until power is interrupted. Once power is removed, the PTC's core cools and contracts allowing conductive chains to reform and return the device to its low resistance state.

The catalog data for each device specifies a "Typical Power" value. This is the power required to exactly match the heat lost by the tripped device to its ambient surroundings at 23C. By Ohm's Law, power can be stated as:  $W = E^2/R$ . Thus the approximate resistance of a "Tripped" PTC can be determined by:  $R = E^2/W$ , where "E" is the voltage appearing across the PTC (usually the supply's open circuit voltage), and "W" is the Typical Power value for the particular PTC. Since the PPTC acts to maintain a constant internal temperature, its apparent resistance will change based upon applied voltage and, to a lesser degree, ambient conditions. Consider the following example....

A PTC with a Typical Power of 1 watt protecting a circuit using a 60V supply will demonstrate an apparent, tripped

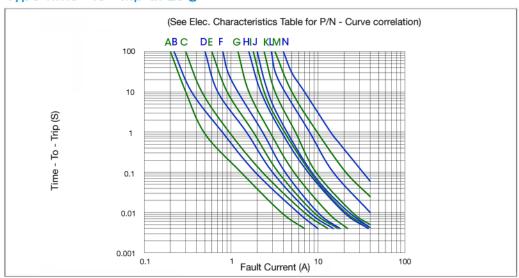
resistance "R" of:

 $R = 60^2/1 = 3.600$  ohms

This same tripped device when used to protect a 12V circuit would now present an apparent resistance of:  $R = 12^2/1 = 144$  ohms

The value for Typical Power is "typical" because any physical factors that affect heat loss (such as ambient temperature or air convection) will somewhat alter the level of power that the PTC needs to maintain its internal temperature. In short, PTCs do not exhibit a constant, quantifiable tripped resistance value.

#### Type Time - To - Trip at 23℃



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### **Mechanical Dimensions and Marking**

(0.25-0.65mm)

D

Marking

(3.07-3.41mm)

B

(4.37-4.73mm)

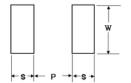
Top and Bottom View

Side View

C

# **Pad Layout**

The dimensions in the table below provide the recommended pad layout.

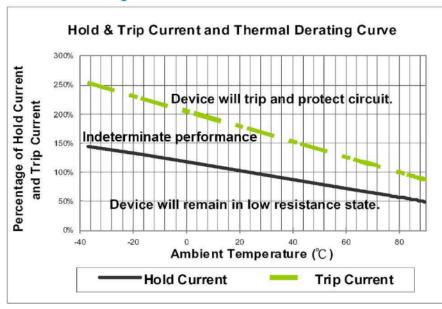


	Р		S	W		
No	minal	Nom	ninal	Nominal		
mm	Inch	mm	Inch	mm	Inch	
3.45	0.136	1.78	0.070	3.50	0.138	

#### **Termination Pad Materials**

Matte Tin - Plated Copper

# **Thermal Derating Curve**



#### Dimensions Marking Code C D illa. "b". IH code. Part Number Min Max Min Max xxxxx b xxx 0ZCG0010FF20 0.60 0ZCG0020FF2C 0.60 0.90 0.30 0.95 0ZCG0020AF2C 0.60 0.90 0.30 0ZCG0030FF2C 0ZCG0035FF2C 0.40 0.70 0.95 0ZCG0035AF2C 0.40 0.70 0.30 0.95 0ZCG0050FF2C 0.35 0.65 0.30 0.95 0ZCG0050AF2C 0.45 0.75 0.30 0.95 0ZCG0075FF2C 0.35 0.65 0.30 0.95 0075 0ZCG0075AF2B 0.80 1.55 0.25 0.95 0ZCG0075BF2B 0.80 1.55 0.25 0.95 0ZCG0110FF2C 0.25 0.55 0.30 0.95 0110 0ZCG0110AF2C 0.25 0.90 0.95 0ZCG0110BF2B 0.80 1.30 0.25 0.95 0ZCG0110CF2B 0.80 1.30 0.25 0.95 0ZCG0125FF2C 0.25 0.55 0.30 0.95 0125 0ZCG0125AF2B 0.50 1.00 0.30 0.95 0ZCG0150FF2C 0.25 0.55 0.95 0150 0ZCG0150AF2C 0.60 1.10 0.25 0.95 0ZCG0150BF2C 0.60 1.55 0.25 0.95 0160 0ZCG0160FF2C 0.25 0.90 0.30 0.95 0ZCG0160AF2C 0.60 1.35 0.25 0.95 0ZCG0160BF2C 0.60 1.35 0.25 0.95 0ZCG0200FF2C 0.55 1.20 0.25 0.95 0.95 0ZCG0200AF2B 0.60 1.55 0.25 0260 0ZCG0260FF2C 0.55 1.20 0.25 0.95 0ZCG0260AF2B 0.80 1.55 0.25 0.95 0ZCG0260BF2B 0.80 1.55 0.25 0.95 0ZCG0300FF2B

#### Cautionary Notes

- Operation beyond the specified maximum ratings or improper use may result in damage and possible electrical arcing and/or flame.
- These Polymer PTC (PPTC) devices are intended for protection against occasional overcurrent/ overtemperature fault conditions and may not be suitable for use in applications where repeated and/or prolonged fault conditions are anticipated.
- Avoid contact of PTC device with chemical solvent. Prolonged contact may adversely impact the PTC performance.
- These PTC devices may not be suitable for use in circuits with a large inductance, as the PTC trip can generate circuit voltage spikes above the PTC rated voltage.
- These devices are intended for use in DC voltage applications only. Use in AC voltage applications should be first discussed with Bel Fuse engineering.
- Not recommended for use on potted or conformal coated PCB's. Restriction of free air flow could affect electrical performance and/or result in device failure. Consult Bel Fuse engineering.
- In the "Indeterminate Performance / grey zone", tripping may occur but cannot be relied upon. For special circumstances considering use within this region, consult Bel Fuse Engineering.
- 8. MSL: 2a (According to IPC J-Std-020).

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# **Surface Mount PTC**

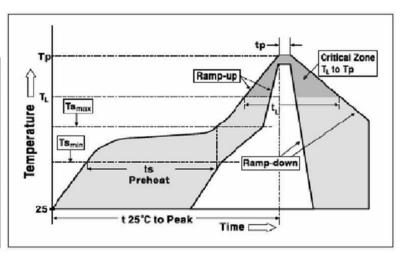
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#### Solder Reflow and Rework Recommendations

Profile Feature	Pb-Free Assembly		
Average Ramp-Up Rate (Tsmax to Tp)	3°C/second max		
Preheat:			
Temperature Min (Tsmin)	150°C		
Temperature Max (Tsmax)	200°C		
Time (tsmin to tsmax)	60-180 seconds		
Time maintained above:			
Temperature(TL)	217°C		
Time (t <sub>L</sub> )	60-150 seconds		
Peak/Classification Temperature(Tp):	260°C		
Time within 5°C of actual Peak:			
Temperature (tp)	20-40 seconds		
Ramp-Down Rate :	6°C/second max.		
Time 25°C to Peak Temperature:	8 minutes max		



#### Solder Reflow

Due to "lead free / RoHS 6" construction of these PTC devices, the required Temperature and Dwell Time in the "Soldering" zone of the reflow profile are greater than those used for non-RoHS devices.

- 1. Recommended reflow methods; IR, vapor phase oven, hot air oven.
- 2. Not Recommended For Wave Solder / Direct Immersion.
- 3. Recommended paste thickness range 0.20 0.25mm.
- 4. Devices are compatible with standard industry cleaning solvents and methods.
- 5. MSL: 2a (According to IPC J-Std-020).

#### Caution

If reflow temperature / dwell times exceed the recommended profile, the electrical performance of the PTC may be affected. Rework: MIL-STD-202G Method 210F, Test Condition A.

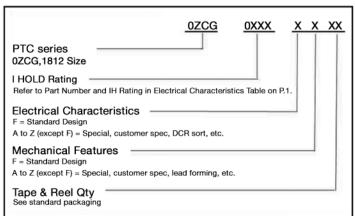
#### Standard Packaging

Part Number	Tape/Reel Qty
0ZCG0010FF2C	
Thru	2,000
0ZCG0075FF2C	
0ZCG0075AF2B	1.500
0ZCG0075BF2B	1,500
0ZCG0110FF2C	0.000
0ZCG0110AF2C	2,000
0ZCG0110BF2B	1,500
0ZCG0110CF2B	1,500
0ZCG0125FF2C	2,000
0ZCG0125AF2B	1,500
0ZCG0150FF2C	
Thru	2,000
0ZCG0200FF2C	
0ZCG0200AF2B	1,500
0ZCG0260FF2C	2,000
0ZCG0260AF2B	
Thru	1,500
0ZCG0300FF2B	

2000 or 1500 fuses in 7 inches dia. Reel, 8mm wide tape, 4mm pitch, per EIA-481(equivalent IEC-286 part 3).

# POWER SOLUTIONS & PROTECTION a bel group

# P/N Explanation and Ordering Information



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# **Mouser Electronics**

**Authorized Distributor** 

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# Bel:

```
        0ZCG0075BF2B
        0ZCG0050AF2C
        0ZCG0020AF2C
        0ZCG0150BF2C
        0ZCG0260FF2C
        0ZCG0110AF2C

        0ZCG0160BF2C
        0ZCG0010FF2C
        0ZCG0020FF2C
        0ZCG0150AF2C
        0ZCG0260AF2B
        0ZCG0150FF2C

        0ZCG0035FF2C
        0ZCG0160AF2C
        0ZCG0125AF2B
        0ZCG0075FF2C
        0ZCG0300FF2B
        0ZCG0014FF2C

        0ZCG0110FF2C
        0ZCG0110BF2B
        0ZCG0125FF2C
        0ZCG0050FF2C
        0ZCG0200FF2C
        0ZCG0030FF2C

        0ZCG0035AF2C
        0ZCG0075AF2B
        0ZCG0260BF2B
        0ZCG0160FF2C
        0ZCG0110CF2B
        0ZCG0200AF2B

        0ZCG0200AF2C
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